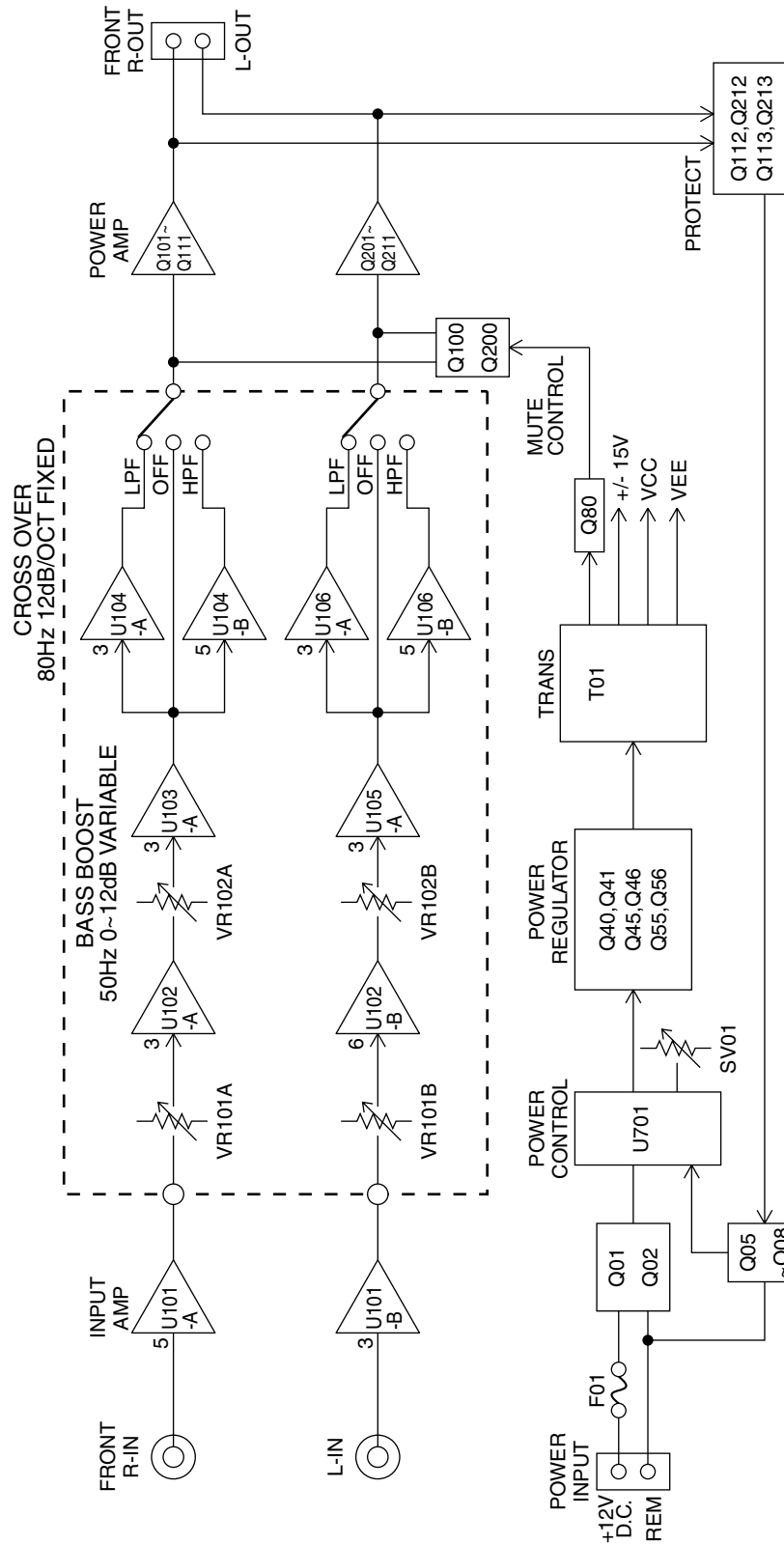


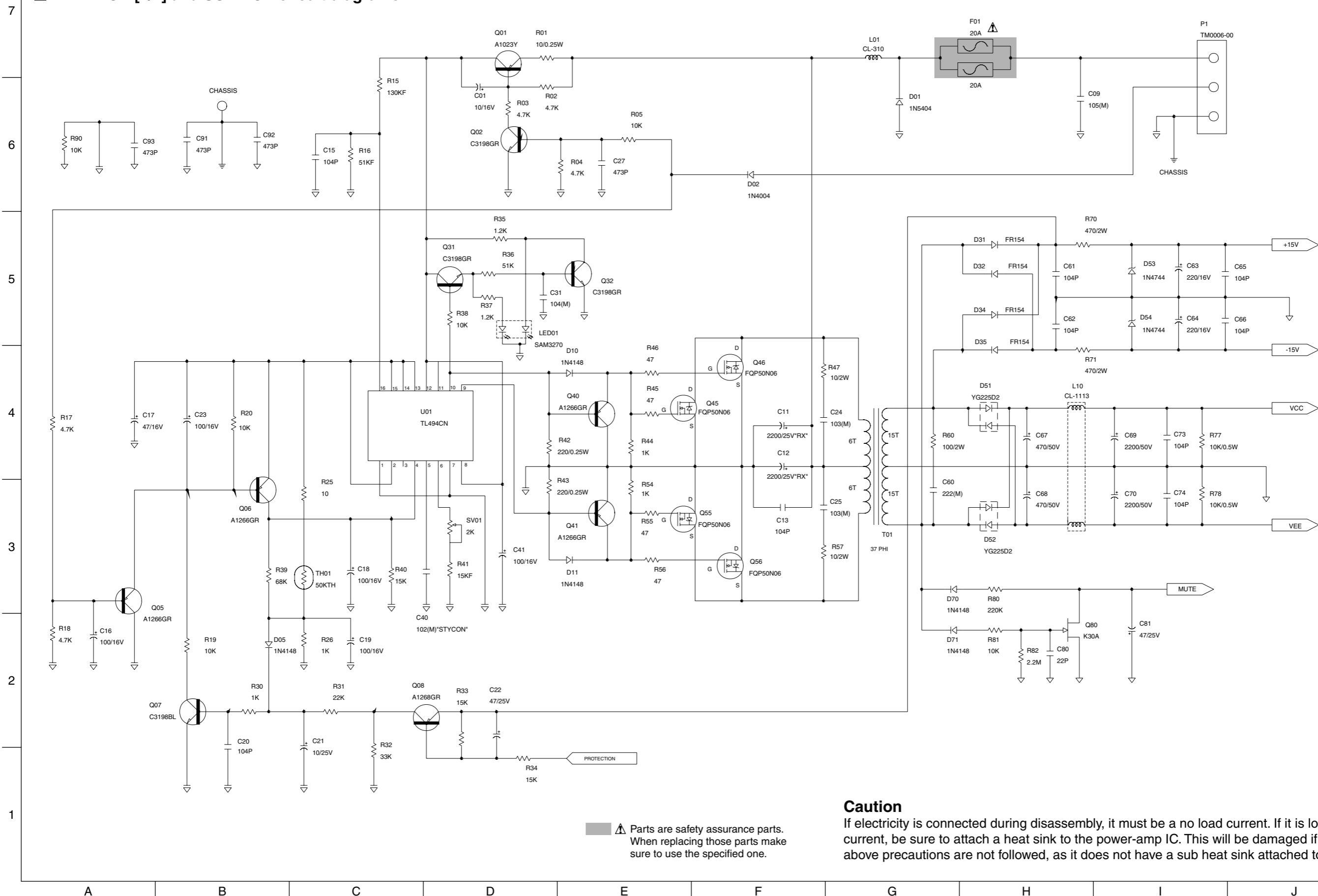
# Circuit block diagram



— MEMO —

# Standard schematic diagrams

## MAIN PCB [1/2] and SUB PCB circuit diagrams



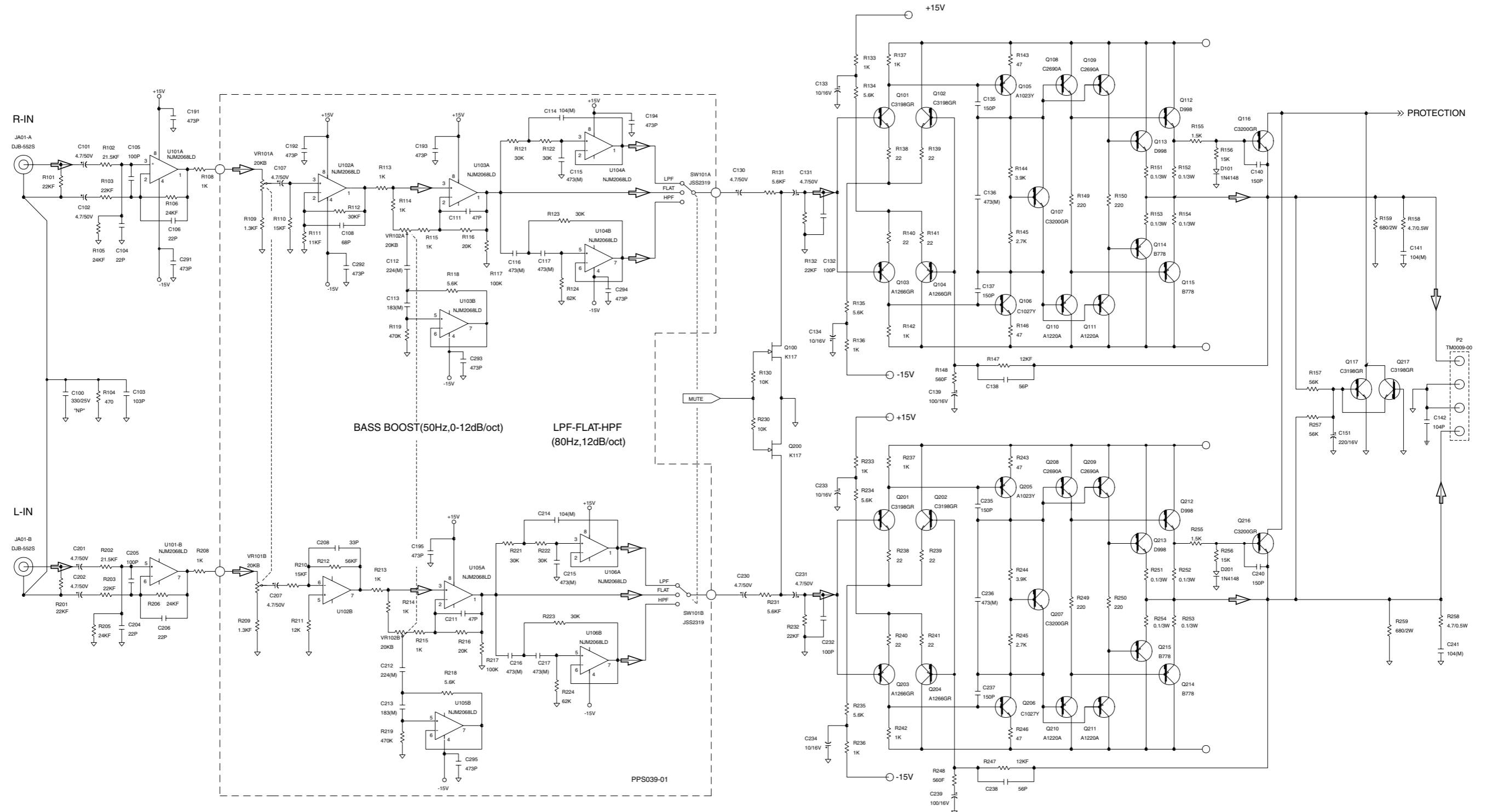
▲ Parts are safety assurance parts. When replacing those parts make sure to use the specified one.

### Caution

If electricity is connected during disassembly, it must be a no load current. If it is load current, be sure to attach a heat sink to the power-amp IC. This will be damaged if the above precautions are not followed, as it does not have a sub heat sink attached to it.

MAIN PCB [2/2] circuit diagrams

7  
6  
5  
4  
3  
2  
1



⇒ Indicates main signal path

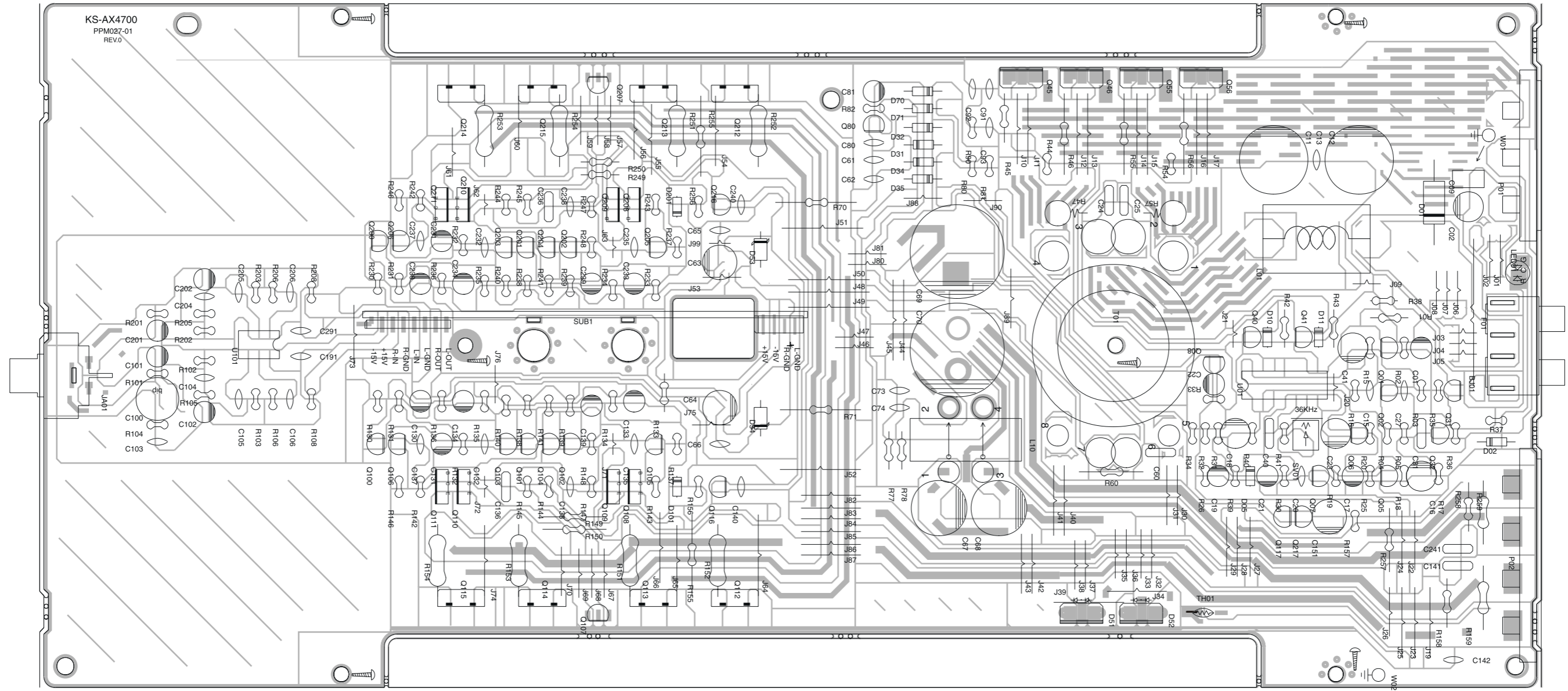
**Caution**  
If electricity is connected during disassembly, it must be a no load current. If it is load current, be sure to attach a heat sink to the power-amp IC. This will be damaged if the above precautions are not followed, as it does not have a sub heat sink attached to it.

A B C D E F G H I J

# Printed circuit boards

## ■ MAIN PCB

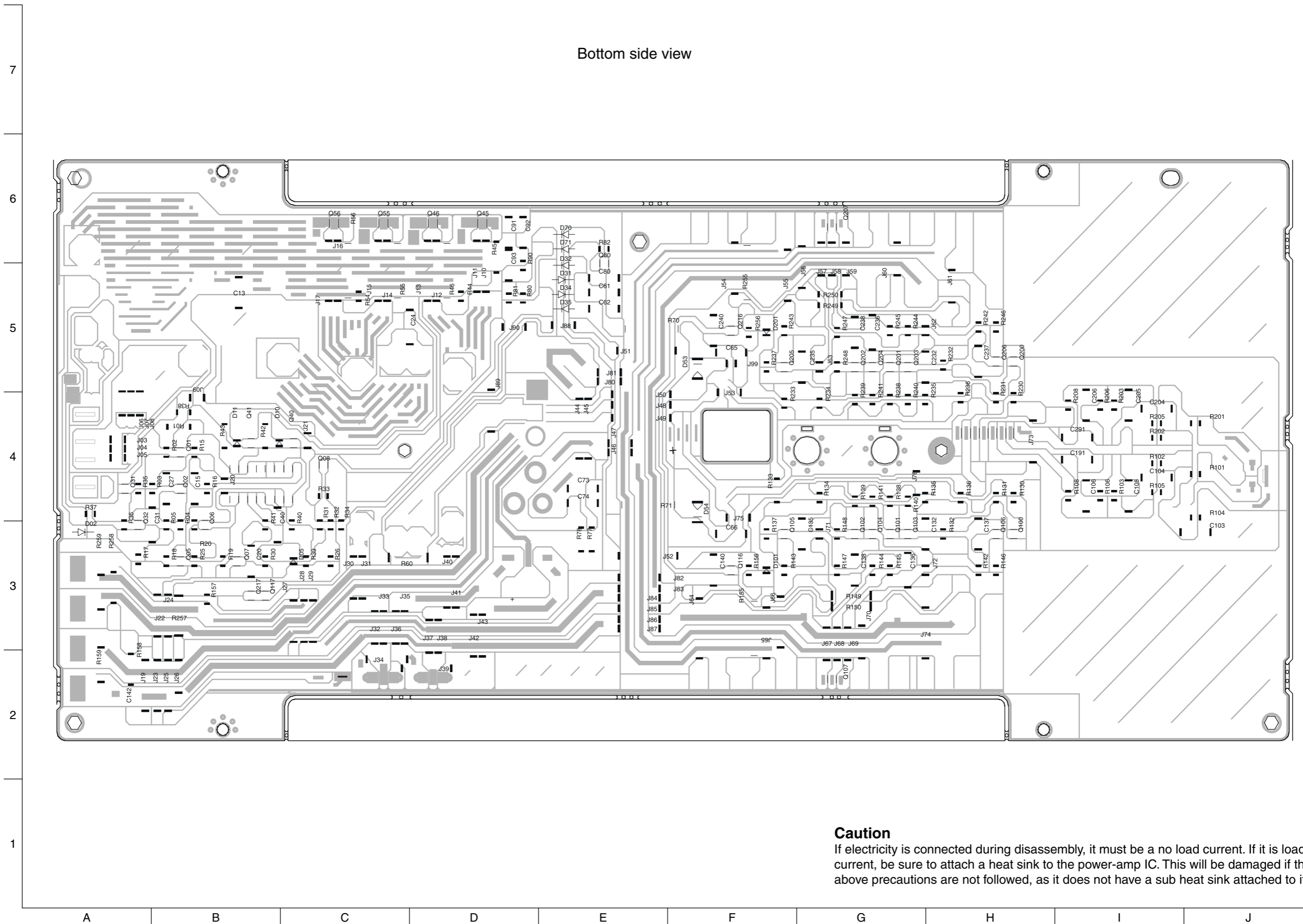
Surface side view



### Caution

If electricity is connected during disassembly, it must be a no load current. If it is load current, be sure to attach a heat sink to the power-amp IC. This will be damaged if the above precautions are not followed, as it does not have a sub heat sink attached to it.

Bottom side view

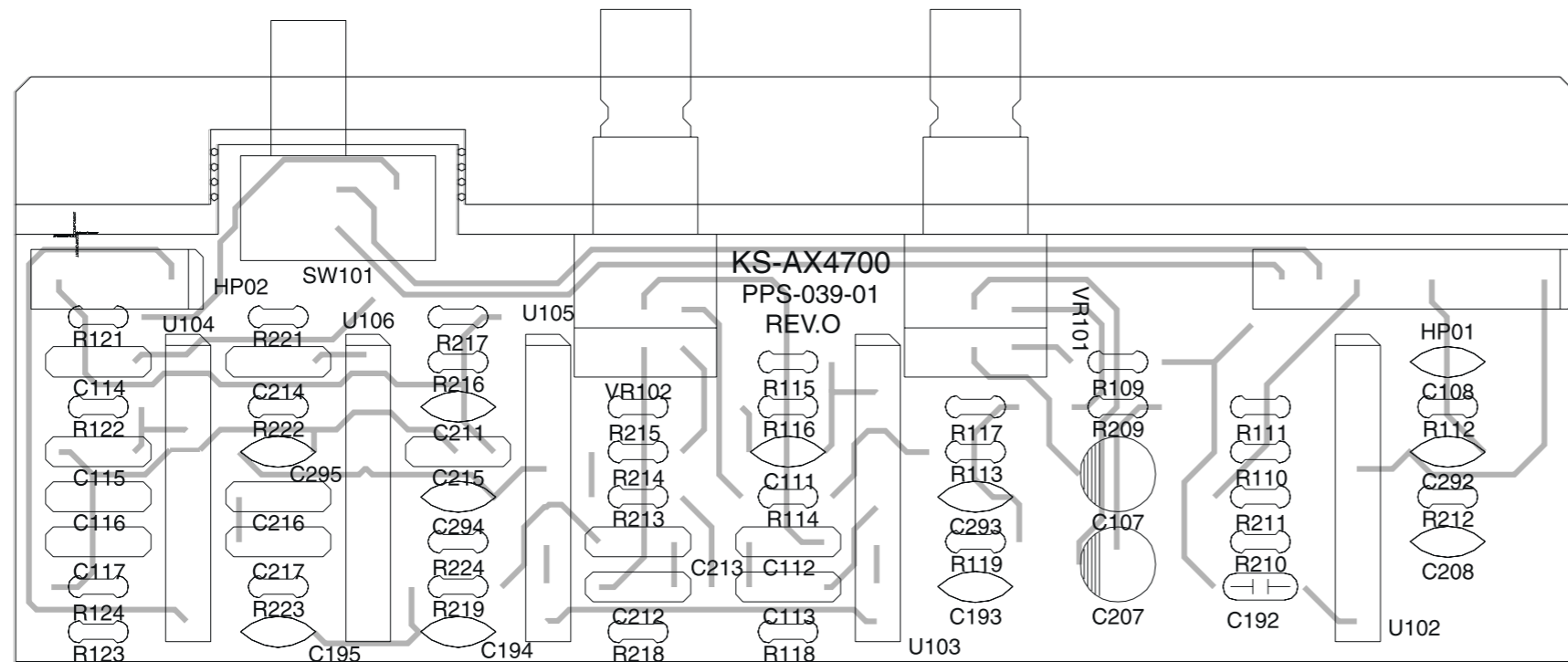


**Caution**

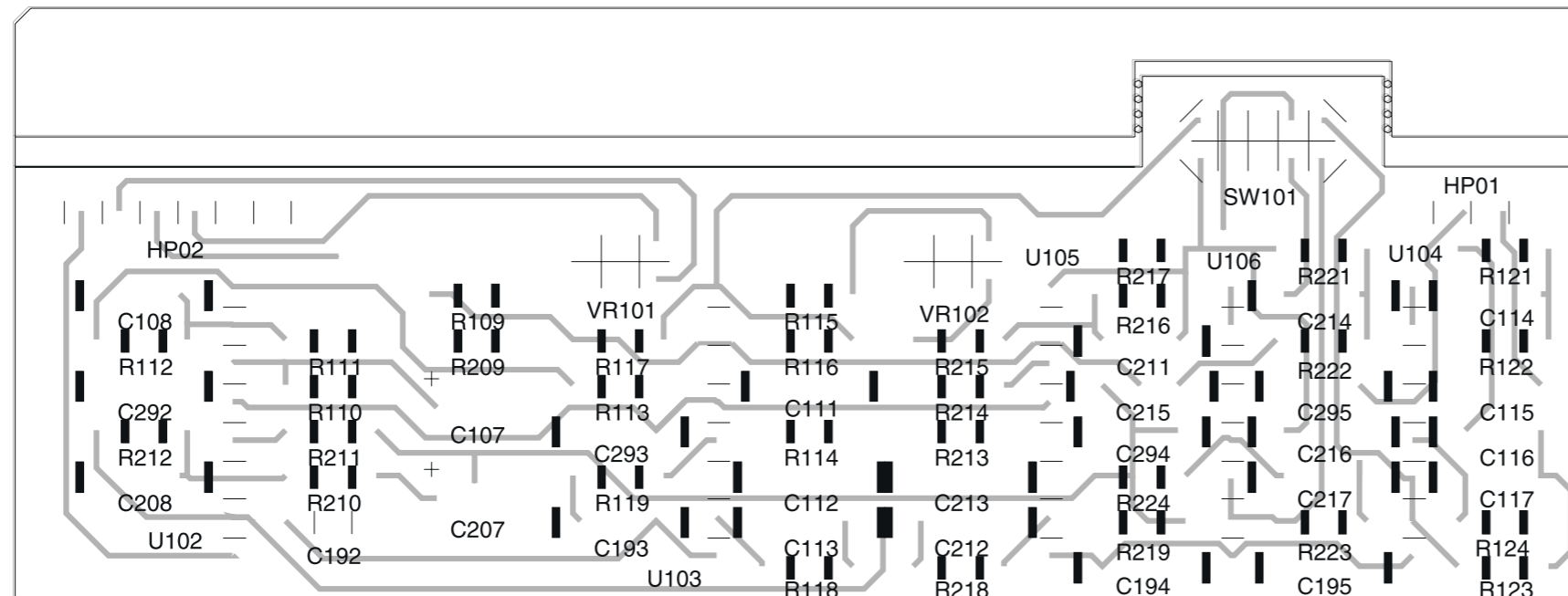
If electricity is connected during disassembly, it must be a no load current. If it is load current, be sure to attach a heat sink to the power-amp IC. This will be damaged if the above precautions are not followed, as it does not have a sub heat sink attached to it.

■ SUB PCB (Volume board)

Surface side view



Bottom side view



**Caution**

If electricity is connected during disassembly, it must be a no load current. If it is load current, be sure to attach a heat sink to the power-amp IC. This will be damaged if the above precautions are not followed, as it does not have a sub heat sink attached to it.

— MEMO —